

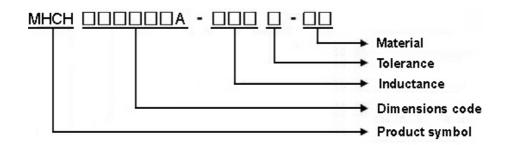
ISO9001 & ISO14001 & TS16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer:		
Customer P/N:		
Drawing No :		
Quantity:	0 Pcs. Date:	2016/01/26
Chilisin P/N:	MHCHL201610A-	SERIES-Q8
	SPECIFICATION ACCEPTED BY:	
COMPONENT		
ENGINEER		
ELECTRICAL		
ENGINEER		
MECHANICAL		
ENGINEER	<u> </u>	
APPROVED		
REJECTED		
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奇力新電子(河南)有限公 Chilisin Electronics (Henan) Co XiuWu Xian, industry gathering JiaoZuo, Henan China Postal Code:454350 TEL:+86-391-717-0682 FAX:+86-391-717-0666	o., Ltd. 句<i>J</i>新电士(穌外 parea	Suzhou) Co., Ltd. Rd., Suzhou New District, 2350
Drawn by 陳瑞揚 ryan.chen	Checked by 張鈺雯 chang.yuwen	Approved by 鍾瑞民 jacky.chung

- 1 Scope: This specification applies to Molding power inductors
- 2 Part Numbering:



3 Rating:

Operating Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (Including self - temperature rise)

Storage Temperature: $-4.0 \,^{\circ}\text{C} \sim 1.2.5 \,^{\circ}\text{C}$ (after PCB)

 $-5\,^{\circ}\mathrm{C} \sim 3\,\,5\,^{\circ}\mathrm{C}$, Humidity $4\,\,5\,\% \sim 8\,\,5\,\%$ (before PCB)

4 Marking:

No Marking

5 Standard Testing Condition

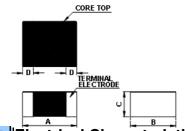
	In case of doubt		
Temperature	Ordinary Temperature(15 to 35℃)	20±2 ℃	
Humidity	Ordinary Humidity(25 to 85% RH)	60 to 70 % RH	



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MHCHL201610A Series Specification

6 Configuration and Dimensions:



Dimensions in mm					
TYPE	MHCHL201610A				
Α	2.0±0.2				
В	1.6 ±0.2				
С	1.0 Max.				
D	0.5 <u>+</u> 0.3				

7 Electrical Characteristics:

Part No.	Inductance (uH)	Test Freq.	Irms(A) Max.(Typ)	Isat(A) Max.(Typ)	RDC(mΩ) Max.(Typ)	SRF (MHz)Min.	Tolerance (±%)
MHCHL201610A-R24M-Q8	0.24	2MHz,0.2V	3.9(4.8)	5.6(7.0)	27(21)	180	20
MHCHL201610A-R33M-Q8	0.33	2MHz,0.2V	4.7(5.1)	5.3(6.0)	23(17.5)	124	20
MHCHL201610A-R47M-Q8	0.47	2MHz,0.2V	3.5(4.2)	3.9(4.8)	42(33)	100	20
MHCHL201610A-R68M-Q8	0.68	2MHz,0.2V	2.7(3.4)	3.2(4.0)	56(43)	73	20
MHCHL201610A-1R0M-Q8	1	2MHz,0.2V	2.5(3.1)	2.9(3.6)	65(53)	67	20
MHCHL201610A-1R5M-Q8	1.5	2MHz,0.2V	2.3(2.7)	2.5(2.8)	85(75)	51	20
MHCHL201610A-2R2M-Q8	2.2	2MHz,0.2V	1.8(2.2)	2.4(2.7)	135(112)	37	20

NOTE:

^{1.}Operating temperature range $-4~0~\% \sim 1~2~5~\%$ (Including self - temperature rise)

^{2.} Isat for Inductance drop 30% from its value without current.

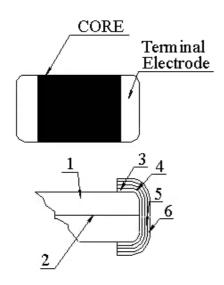
^{3.}Irms for a 40°C temperature rise from 25°C ambient.

^{4.}All test data is referenced to 25 $\!\!\!\!\!\!^{\,\circ}_{\,\circ}$ ambient



8 MHCHL201610A Series

8.1 Construction:



8.2 Material List:

NO	Part	Description
1	Core	Metal Powder
2	Wire	Copper wire
3	Sputter/Plating	Cu
4	Silver Electrode	Ag
5	Plating	Ni
6	Plating	Sn



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MHCHL201610A Series Specification 9 Reliability Of Molding power inductors

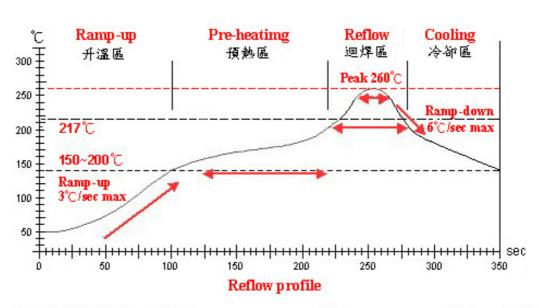
1-1.Mechanical Performance

No	Item	Specification	Test Method
1-1-1	Flexure Strength	The forces applied on the right conditions must not damage the terminal electrode and the metal body	Test device shall be soldered on the substrate Substrate Dimension: 100x40x1.6mm Deflection: 2.0mm Keeping Time: 30sec
1-1-2	Vibration	Appearance:No damage (for microscope of CASTOR MZ-45 20X) Inductance change shall be within ±20%	Test device shall be soldered on the substrate Oscillation Frequency: 10 to 55 to 10 HZ for 17hin Amplitude: 1.5mm Time: 2hrs for each axis (X, Y & Z), total 6hrs
1-1-3	Resistance to Soldering Heat		Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 260±5°C Immersion Time: 10±1sec
1-1-4	Solder ability	The electrodes shall be at least 95% covered with new solder coating	Pre-heating: 150°C, 1min Solder Composition: Sn/Ag3.0/Cu0.5(Pb-Free) Solder Temperature: 245±5°C Immersion Time: 4±1sec
1-1-5	Terminal Strength Test	No split termination Chip F Mounting Pad	Test device shall be soldered on the substrate then apply a force in the direction of the arrow Force : 5N Keeping Time: 10±1sec

1-2 Environmental Performance

No	Item	Specification		Test Method		
1-2-1	Temperature Cycle	Appearance: No damage	One cycle:	· -	-	
		Inductance:within±20% of	Step	Temperature (°C)		Time (min)
		initial value	1	-40±3		30
			2	25±2		3
			3	125±3		__ 30
			4	25±2	4	3
			Total: 100d	cycles	l'	J
			Measured	after exposure in the room co	ndi	tion for 24hrs
1-2-2	1-2-2 Humidity Resistance		Temperature: 60±2°C			
			Relative H	umidity: 90 ~ 95% / Time: 5 <mark>0</mark>	Ohrs	3
			Measured	after exposure in the room co	ndi	tion for 24hrs
1-2-3	High		Temperatu	ıre: 85±3℃	√'	
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs	'	
			Measured	after exposure in the room co	ndi	tion for 24hrs
1-2-4	Low		Temperatu	ıre: -40±3°C		
	Temperature Resistance		Relative H	umidity: 0% / Time: 500hrs		
			Measured	after exposure in the room co	ndi	tion for 24hrs





Lead-Free(LF) 標準溫度分析範圍

Refer to J-STD-020C

管制項目 Item.	升溫區 Ramp-up	預熱區 Pre-heatimg	迴焊區 Reflow	Peak Temp	冷卻區 Cooling
溫度範圍 Temp.scope	R.T. ~150°C	150°C ~ 200°C	217℃	260±5°C	Peak Temp. ~ 150°C
標準時間 Time spec.	_	60 ~ 180 sec	60 ~ 150 sec	20 ~ 40 sec	-
實際時間 Time result	_	75 ~ 100 sec	90 ~ 120 sec	20 ~ 35 sec	/ _

NOTE:

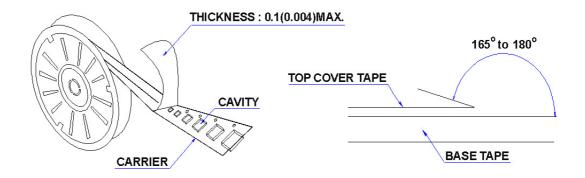
- 1. Re-flow possible times: within 2 times
- 2. Nitrogen adopted is recommended while in re-flow



11 Packaging:

11.1 Packaging -Cover Tape

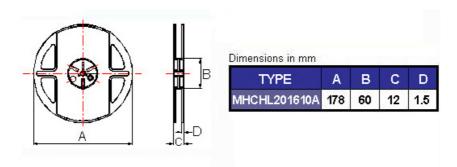
The force for tearing off cover tape is 10 to 100 grams in the arrow direction.



11.2 Packaging Quantity

TYPE	PCS/REEL
MHCHL201610A	3000

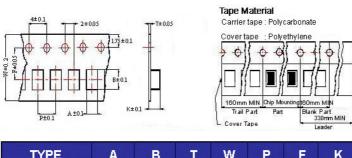
11.3 Reel Dimensions





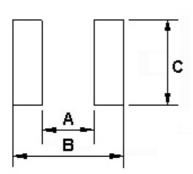
11 Packaging:

11.4 Tape Dimensions in mm



TYPE A B T W P F K MHCHL201610A 1.8 2.2 0.22 8 4 3.5 1.15

12 Recommended Land Pattern:



Dimensions in mm

TYPE	Α	В	O
MHCHL201610A	0.7	2.3	1.8

13 Note:

- 1. Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.
- 2. Do not knock nor drop.
- 3. All the items and parameters in this product specification have been prescribed on the premise that our product is used for the purpose,under the condition and in the environment agreed upon between you and us. You are requested not to use our product deviating from such agreement.
- 4. Please keep the distance between transformer/coil and other components (refer to the standard IEC 950)
- 5. After manufacturing process, there might be slight irregular shape on the edge of the products, and it's a normal phenomenon that can be neglected
- 6. The moisture sensitivity level (MSL) of products is classified as level 1.